



# N 沟道增强型场效应晶体管 N-CHANNEL MOSFET FHP3205C/FHD3205C

## 主要参数 MAIN CHARACTERISTICS

ID	130 A
VDSS	68 V
Rdson-typ (@Vgs=10V)	4.6 mΩ
Qg-typ	145nC

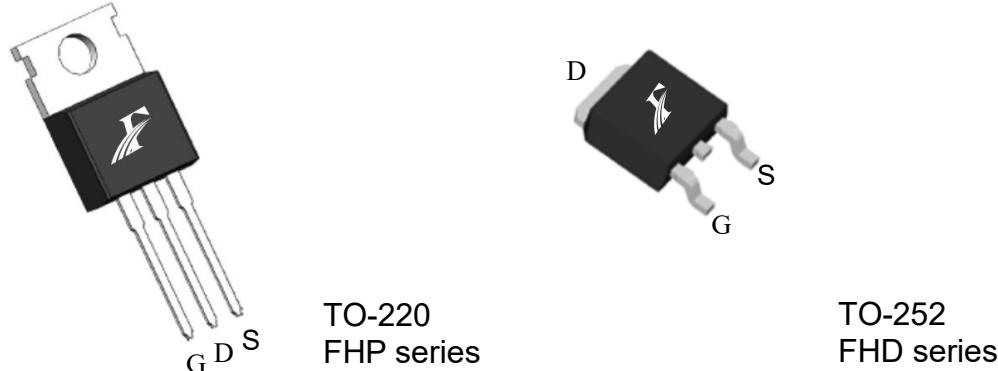
## 用途 APPLICATIONS

12V逆变器	Power management for 12V inverter
同步整流	Synchronous Rectification
电机驱动	Motor driver
不间断电源	UPS
直流转换器	DC-DC Converter
锂电池保护板 (TO-252)	Li Battery Protect Board

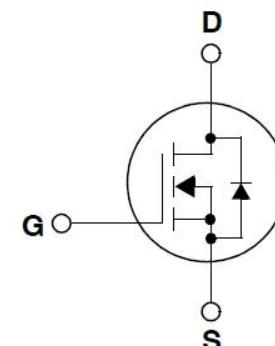
## 产品特性 FEATURES

低栅极电荷	Low gate charge
开关速度快	Fast switching
100% 经过热阻测试	100% DVDS tested
100% 经过雪崩测试	100% avalanche tested
100% Rg 测试	100% Rg tested
高抗 dv/dt 能力	Improved dv/dt capability
沟槽工艺	Trench technology
RoHS 产品	RoHS product

## 封装形式 Package



## 等效电路 Equivalent Circuit



## 绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 <b>Parameter</b>	符号 <b>Symbol</b>	数值 <b>Value</b>		单位 <b>Unit</b>
		FHP3205C/FHD3205C		
最高漏极—源极直流电压 Drain-Source Voltage	VDS	68		V
连续漏极电流* Drain Current -continuous *	I <sub>D</sub> (T <sub>c</sub> =25°C)	130		A
	I <sub>D</sub> (T <sub>c</sub> =100°C)	97		A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	I <sub>DM</sub>	520		A
最高栅源电压 Gate-Source Voltage	V <sub>GS</sub>	±20		V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E <sub>AS</sub>	506		mJ
雪崩电流 (注 1) Avalanche Current (note 1)	I <sub>AR</sub>	25		A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	E <sub>AR</sub>	50		mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0		V/ns
耗散功率 Power Dissipation	P <sub>D</sub> (TC=25°C)	195		W
	-Derate above 25°C	1.56		W/°C
最高结温及存储温度 Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~+150		°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T <sub>L</sub>	300		°C

\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature

## 电特性 ELECTRICAL CHARACTERISTICS

项目 <b>Parameter</b>	符号 <b>Symbol</b>	测试条件 <b>Tests conditions</b>	最小 <b>Min</b>	典型 <b>Typ</b>	最大 <b>Max</b>	单位 <b>Units</b>	
<b>关态特性 Off -Characteristics</b>							
漏—源击穿电压 <b>Drain-Source Voltage</b>	BVDSS	Id=250μA, Vgs=0V	68	-	-	V	
击穿电压温度特性 <b>Breakdown Voltage Temperature Coefficient</b>	ΔBVDSS/Δ TJ	Id=250μA, referenced to 25°C	-	0.05	-	V/°C	
零栅压下漏极漏电流 <b>Zero Gate Voltage Drain Current</b>	Idss	Vds=68V, Vgs=0V, Tc=25°C Vds=54V, Tc=125°C	- -	- -	1 10	μA μA	
栅极体漏电流 <b>Gate-body leakage current</b>	IGSS (F/R)	Vds=0V, Vgs =±20V	-	-	±100	nA	
<b>通态特性 On-Characteristics</b>							
阈值电压 <b>Gate Threshold Voltage</b>	VGS(th)	Vds = Vgs , Id=250μA	2.0	-	4.0	V	
静态导通电阻 <b>Static Drain-Source On-Resistance</b>	RDS(ON)	Vgs =10V , Id=30A	-	4.6	5.4	mΩ	
正向跨导 <b>Forward Transconductance</b>	gfs	Vds = 5V, Id=30A (note 4)	-	65	-	S	
<b>动态特性 Dynamic Characteristics</b>							
栅电阻 <b>Gate Resistance</b>	Rg	f=1.0MHz	-	3.0	-	Ω	
输入电容 <b>Input capacitance</b>	Ciss	Vds=34V, Vgs =0V, f=1.0MHz	-	6550	-	pF	
输出电容 <b>Output capacitance</b>	Coss		-	540	-		
反向传输电容 <b>Reverse transfer capacitance</b>	Crss		-	385	-		
<b>开关特性 Switching Characteristics</b>							
延迟时间 <b>Turn-On delay time</b>	td(on)	Vds=34V, Id=30A, Rg=4.7Ω Vgs =10V (note 4, 5)	-	31	-	ns	
上升时间 <b>Turn-On rise time</b>	tr		-	75	-	ns	
延迟时间 <b>Turn-Off delay time</b>	td(off)		-	131	-	ns	
下降时间 <b>Turn-Off Fall time</b>	tf		-	58	-	ns	
栅极电荷总量 <b>Total Gate Charge</b>	Qg	Vds =54V , Id=30A , Vgs =10V (note 4, 5)	-	145	-	nC	
栅—源电荷 <b>Gate-Source charge</b>	Qgs		-	30	-	nC	
栅—漏电荷 <b>Gate-Drain charge</b>	Qgd		-	51	-	nC	
<b>漏—源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings</b>							
正向最大连续电流 <b>Maximum Continuous Drain -Source Diode Forward Current</b>	Is		-	-	130	A	
正向最大脉冲电流 <b>Maximum Pulsed Drain-Source Diode Forward Current</b>	Ism		-	-	520	A	
正向压降 <b>Drain-Source Diode Forward Voltage</b>	Vsd	Vgs=0V, Is=45A	-	0.9	1.3	V	
反向恢复时间 <b>Reverse recovery time</b>	trr	Vgs=0V, Is=30A ,dI/dt=100A/μs (note 4)	-	42	-	ns	
反向恢复电荷 <b>Reverse recovery charge</b>	Qrr		-	64	-	nC	

## 热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	最大值 Max	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	R <sub>th(j-c)</sub>	0.64	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	R <sub>th(j-A)</sub>	62.5	°C/W

注释:

- 1: 脉冲宽度由最高结温限制
- 2: L=0.5mH, I<sub>AS</sub>=45A, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω,起始结温 T<sub>J</sub>=25°C
- 3: I<sub>SD</sub> ≤30A,di/dt ≤100A/μs,V<sub>DD</sub>≤BV<sub>DSS</sub>,起始结温 T<sub>J</sub>=25°C
- 4: 脉冲测试: 脉冲宽度 ≤300μs,占空比≤2%
- 5: 基本与工作温度无关

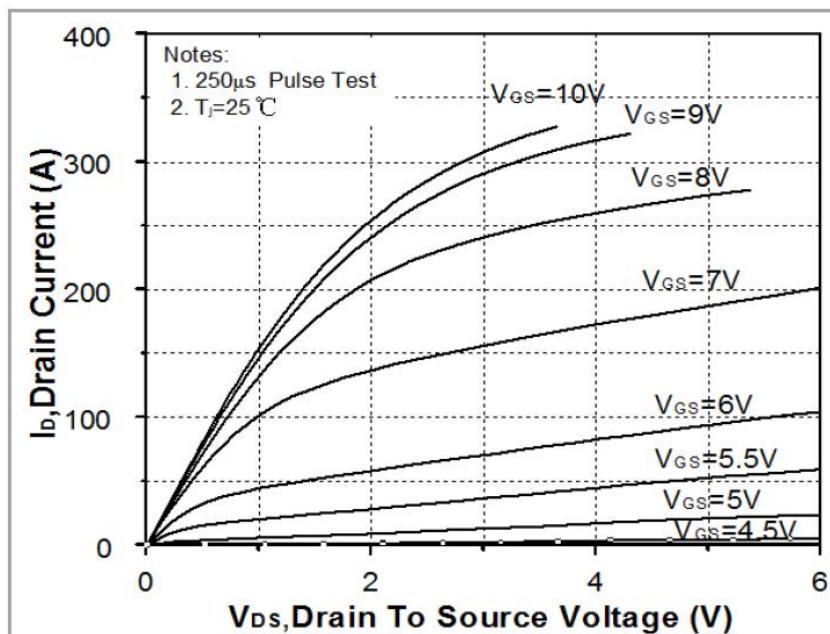
Notes:

- 1: Pulse width limited by maximum junction temperature
- 2: L=0.5mH, I<sub>AS</sub>=45A, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω,Starting T<sub>J</sub>=25°C
- 3: I<sub>SD</sub> ≤30A,di/dt ≤100A/μs,V<sub>DD</sub>≤BV<sub>DSS</sub>, Starting T<sub>J</sub>=25°C
- 4: Pulse Test: Pulse Width ≤300μs,Duty Cycle≤2%
- 5: Essentially independent of operating temperature

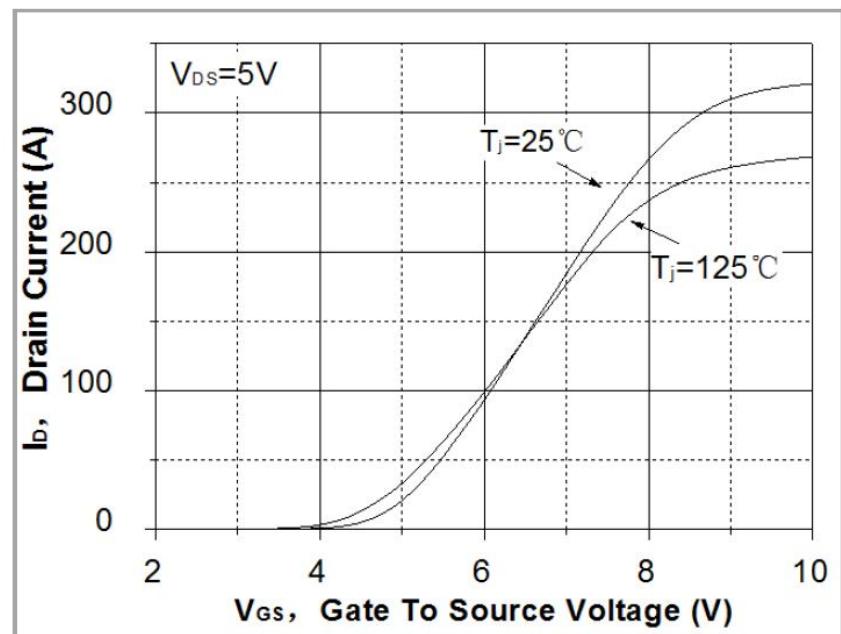
## Typical Characteristics

### 典型特性曲线

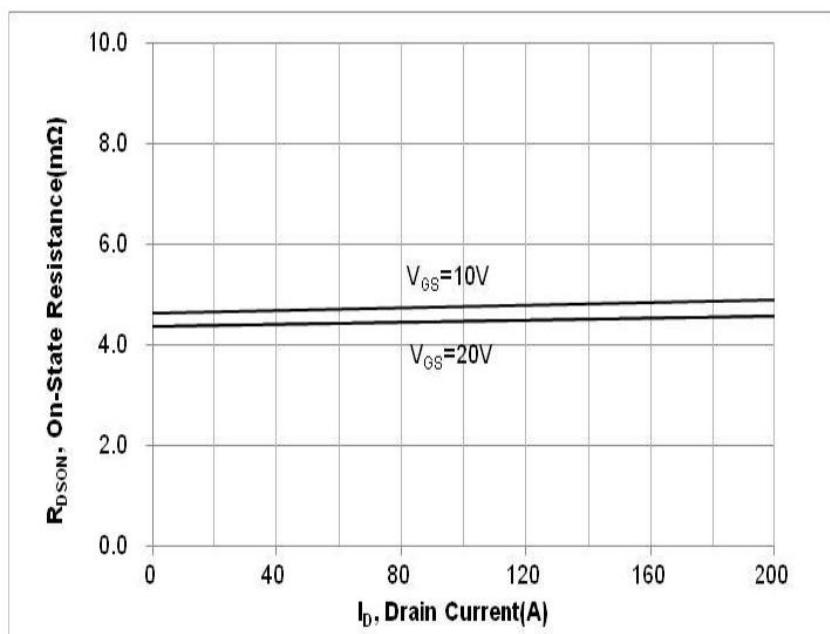
**Fig. 1. On-state characteristics**



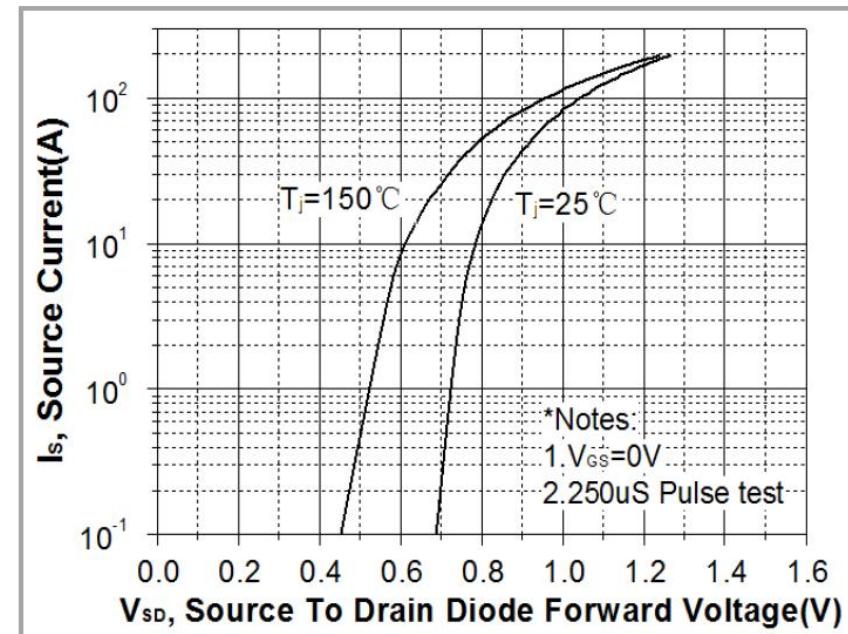
**Fig. 2. Transfer Characteristics**



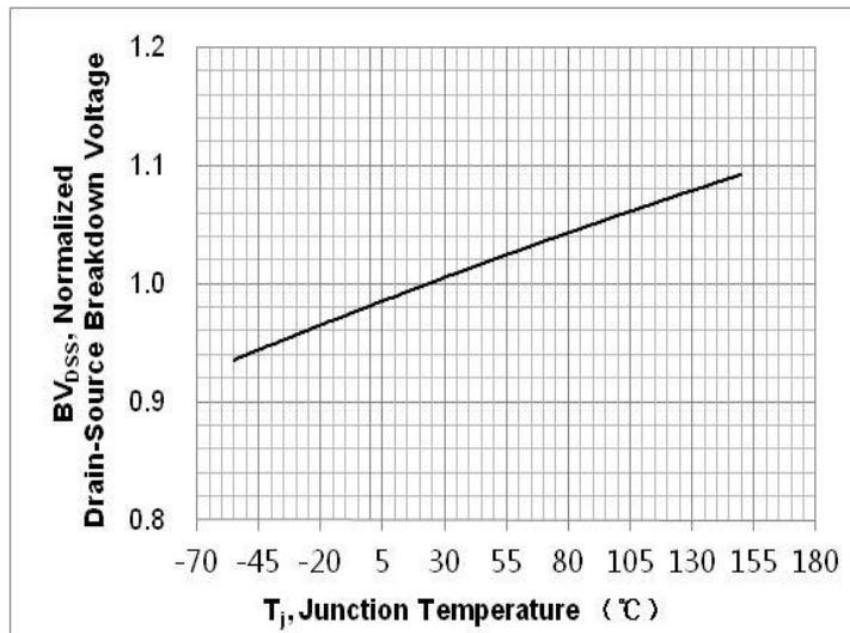
**Fig. 3. On-resistance variation vs. drain current and gate voltage**



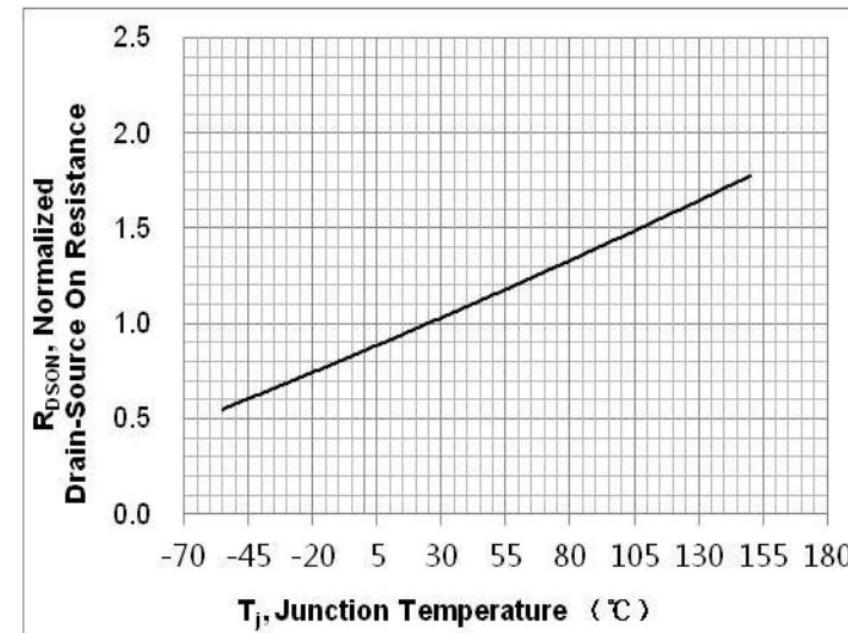
**Fig. 4. On-state current vs. diode forward voltage**



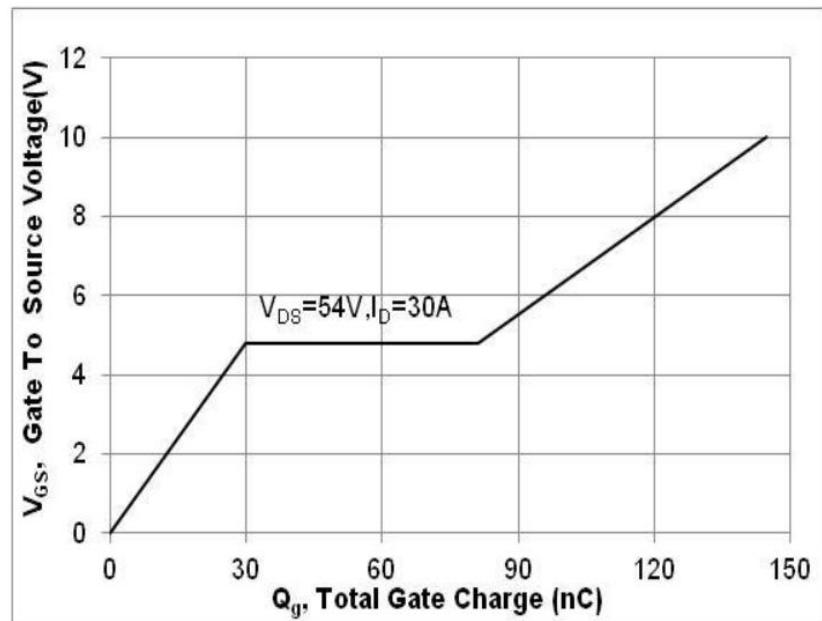
**Fig 5. Breakdown voltage variation vs. junction temperature**



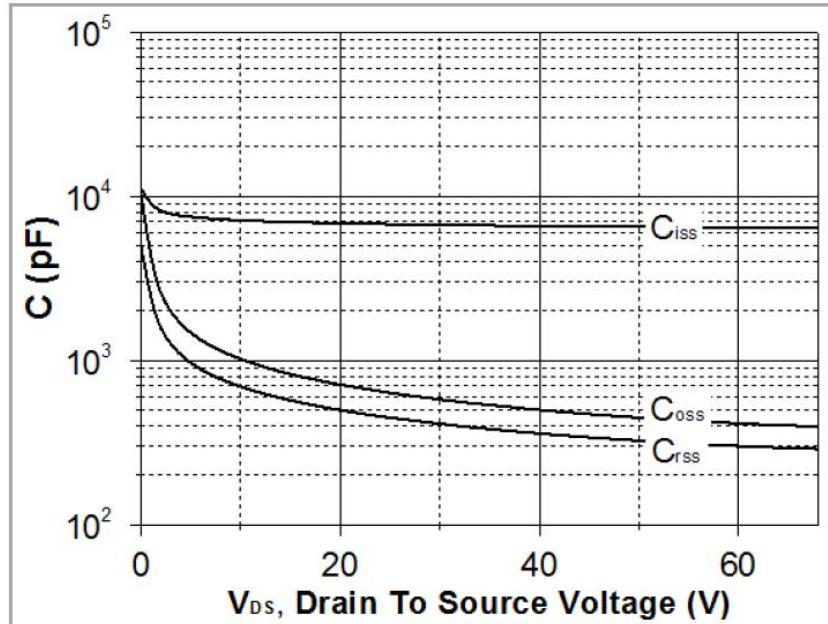
**Fig. 6. On-resistance variation vs. junction temperature**



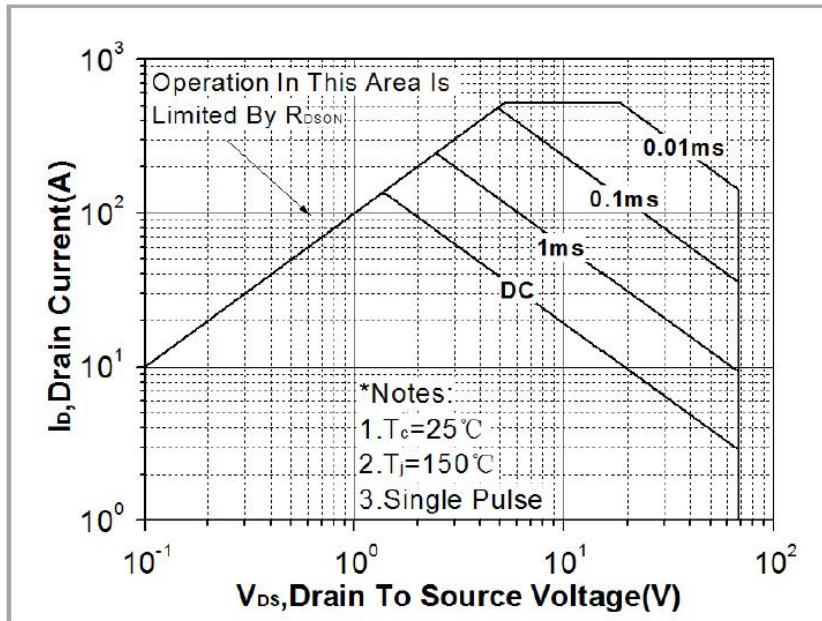
**Fig. 7. Gate charge characteristics**



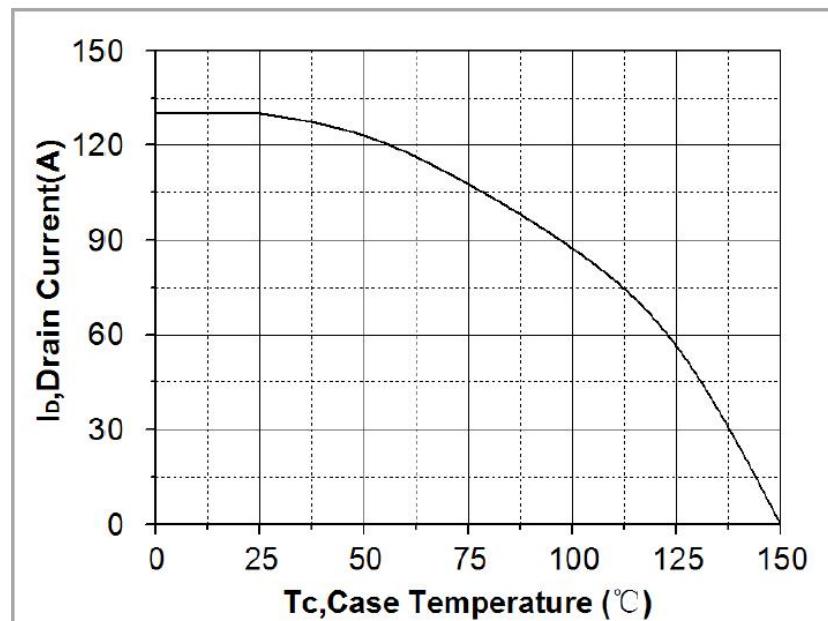
**Fig. 8. Capacitance Characteristics**



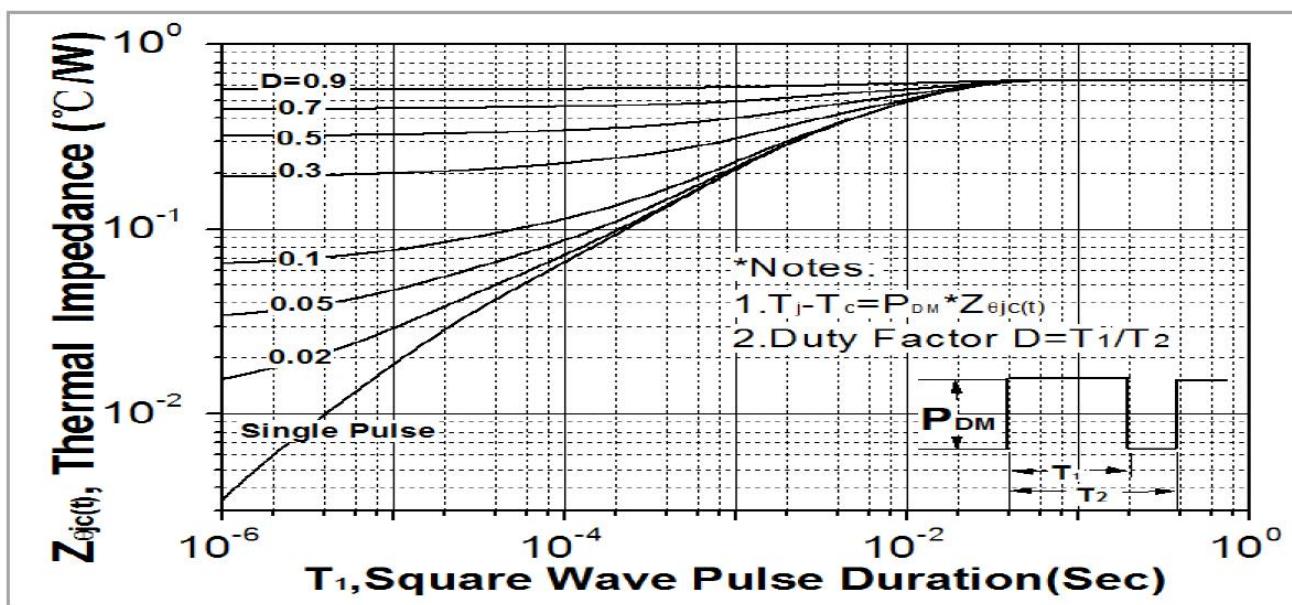
**Fig. 9. Maximum safe operating area**



**Fig. 10. Maximum drain current vs. case temperature**

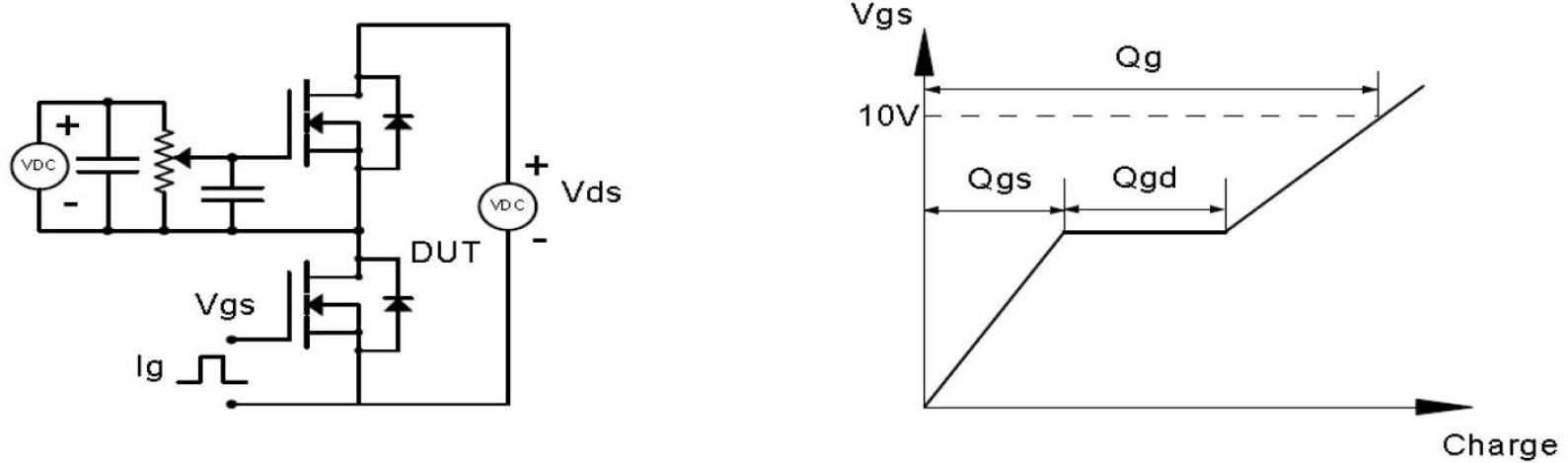


**Fig. 11. Transient thermal response curve**

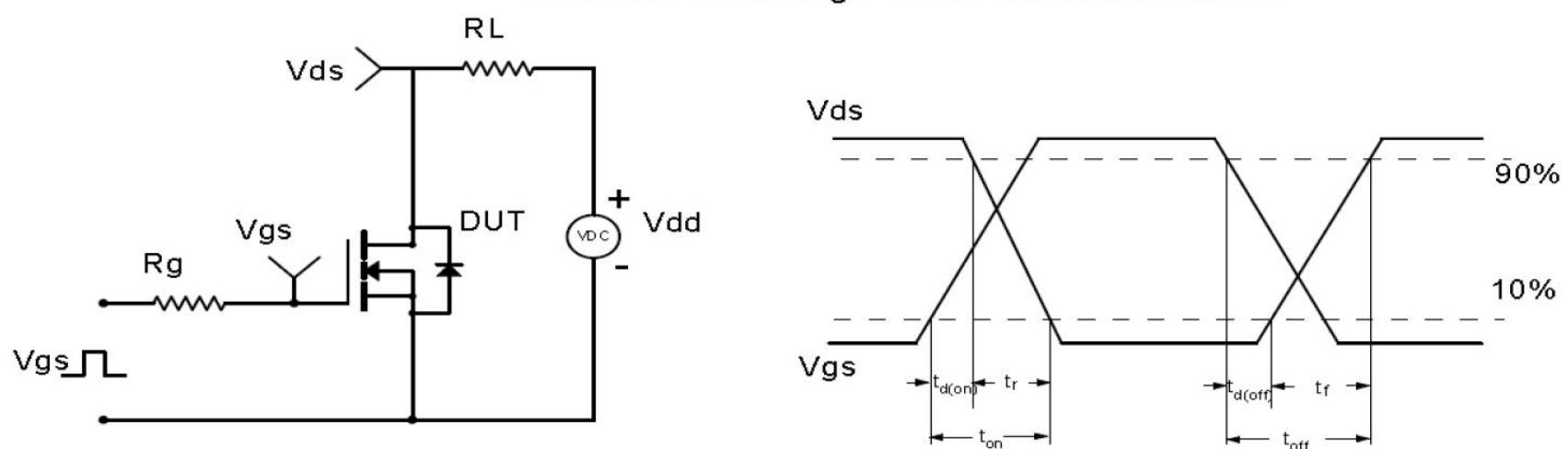


## Test Circuit & Waveform

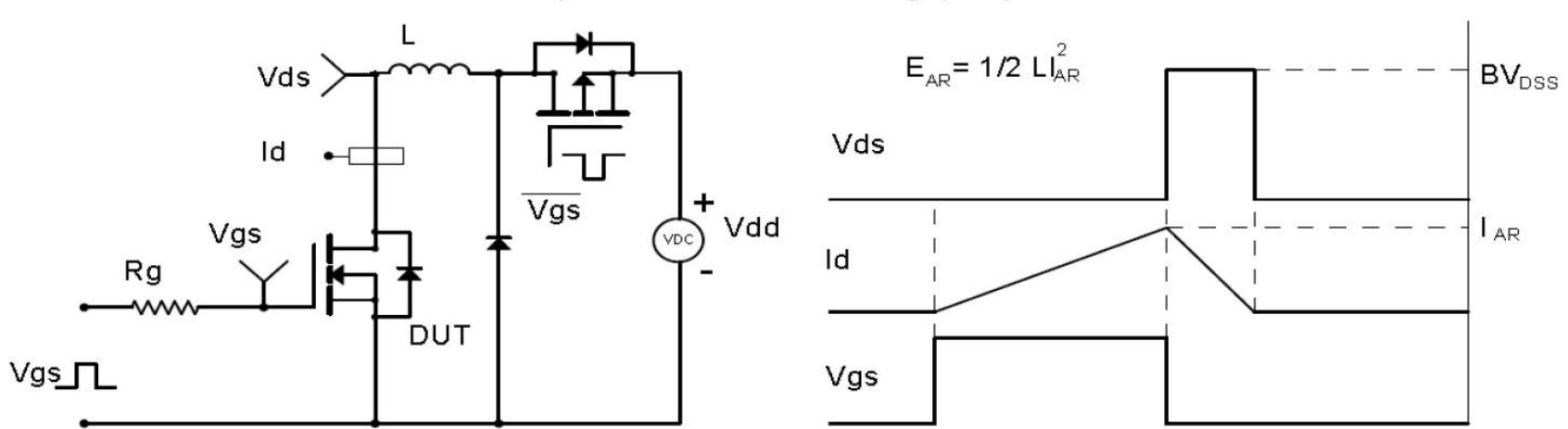
Gate Charge Test Circuit & Waveform



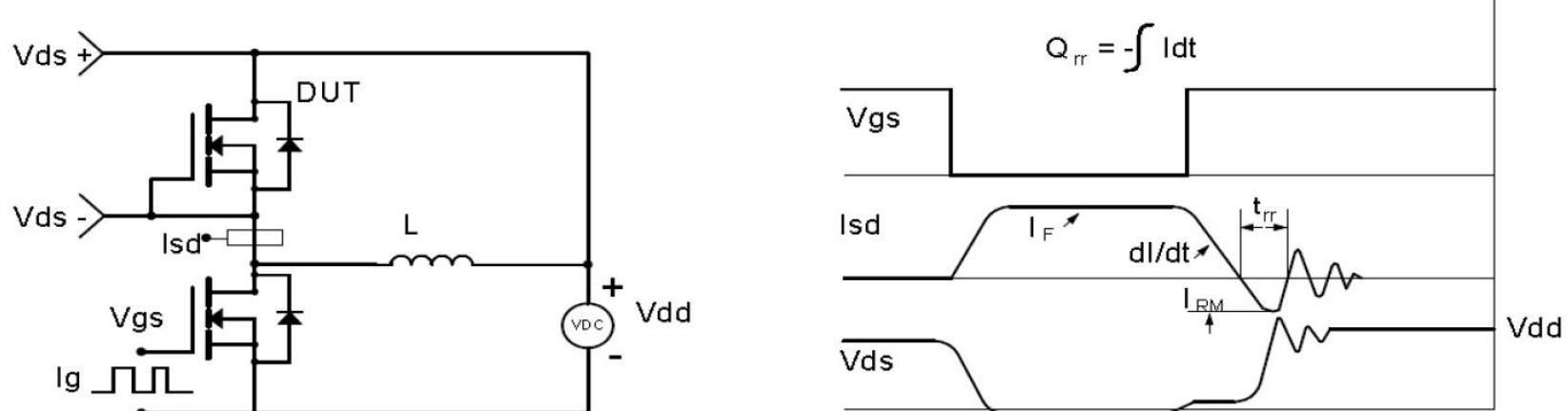
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

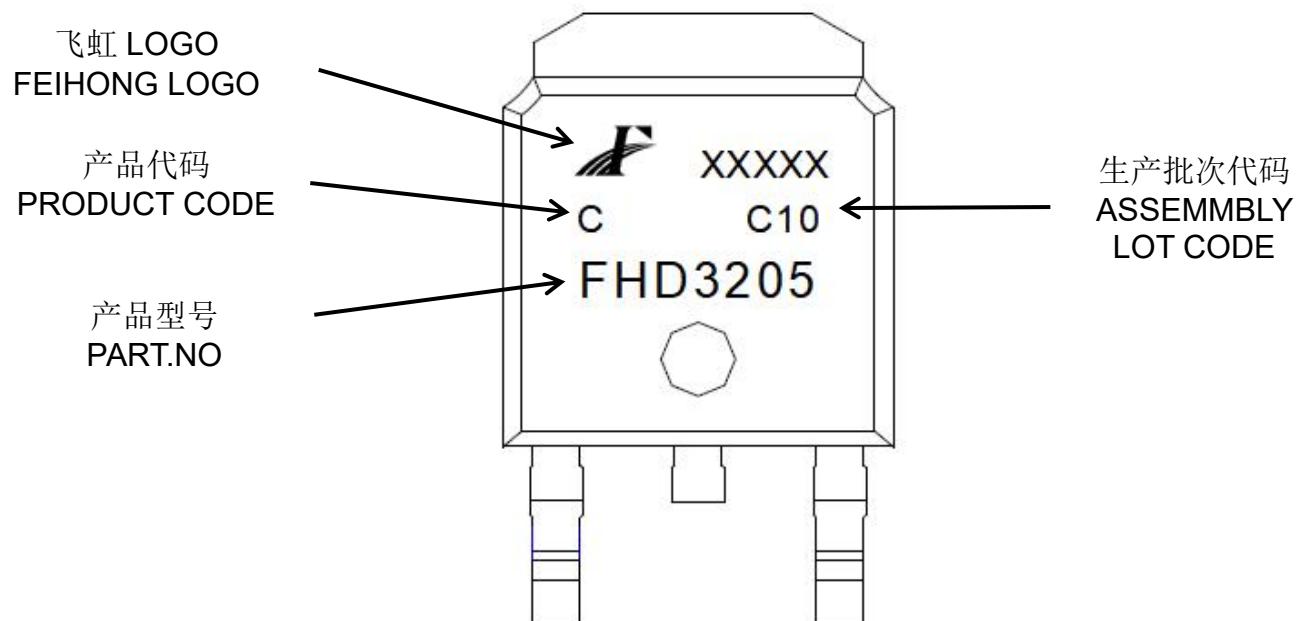
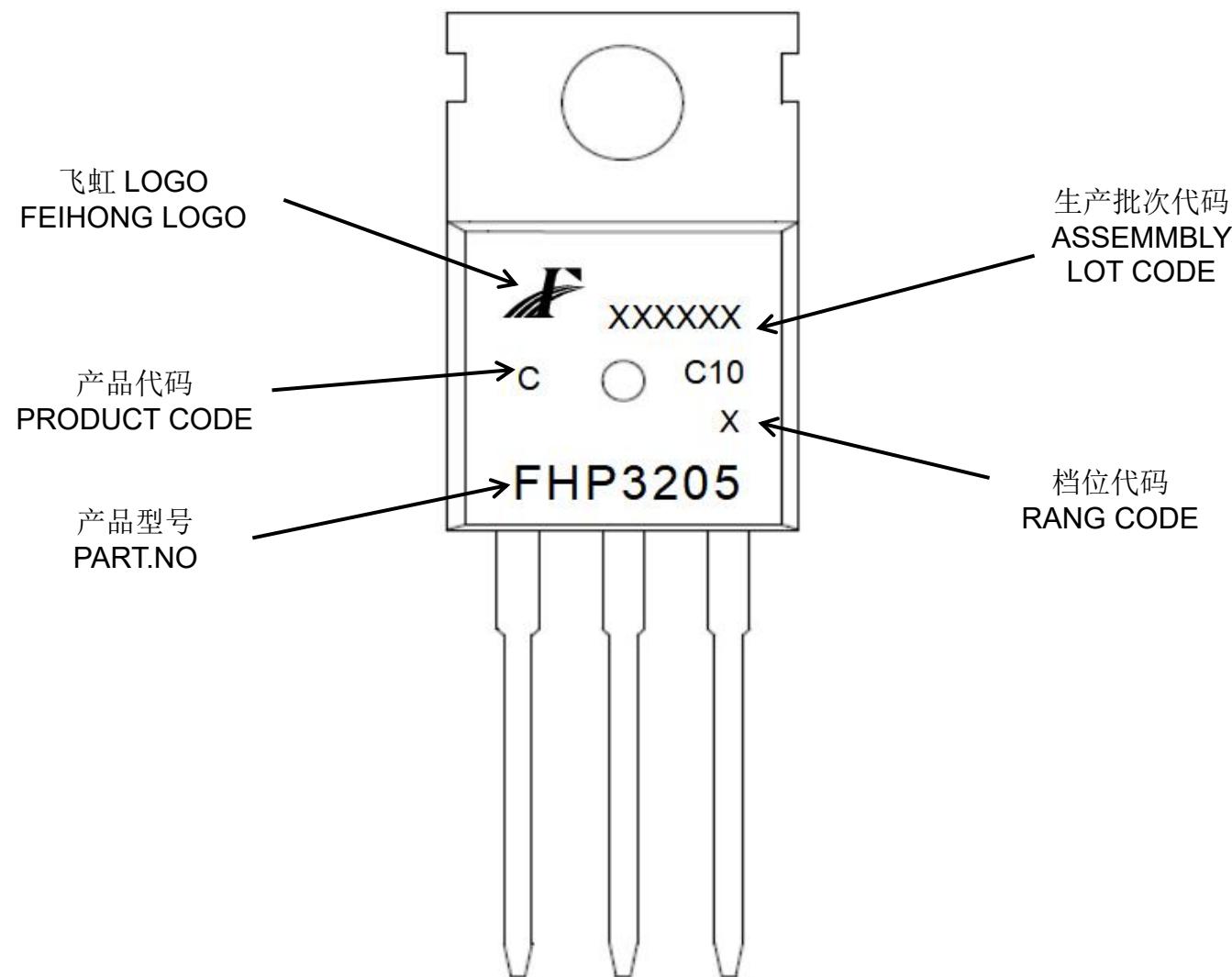


Diode Recovery Test Circuit & Waveforms



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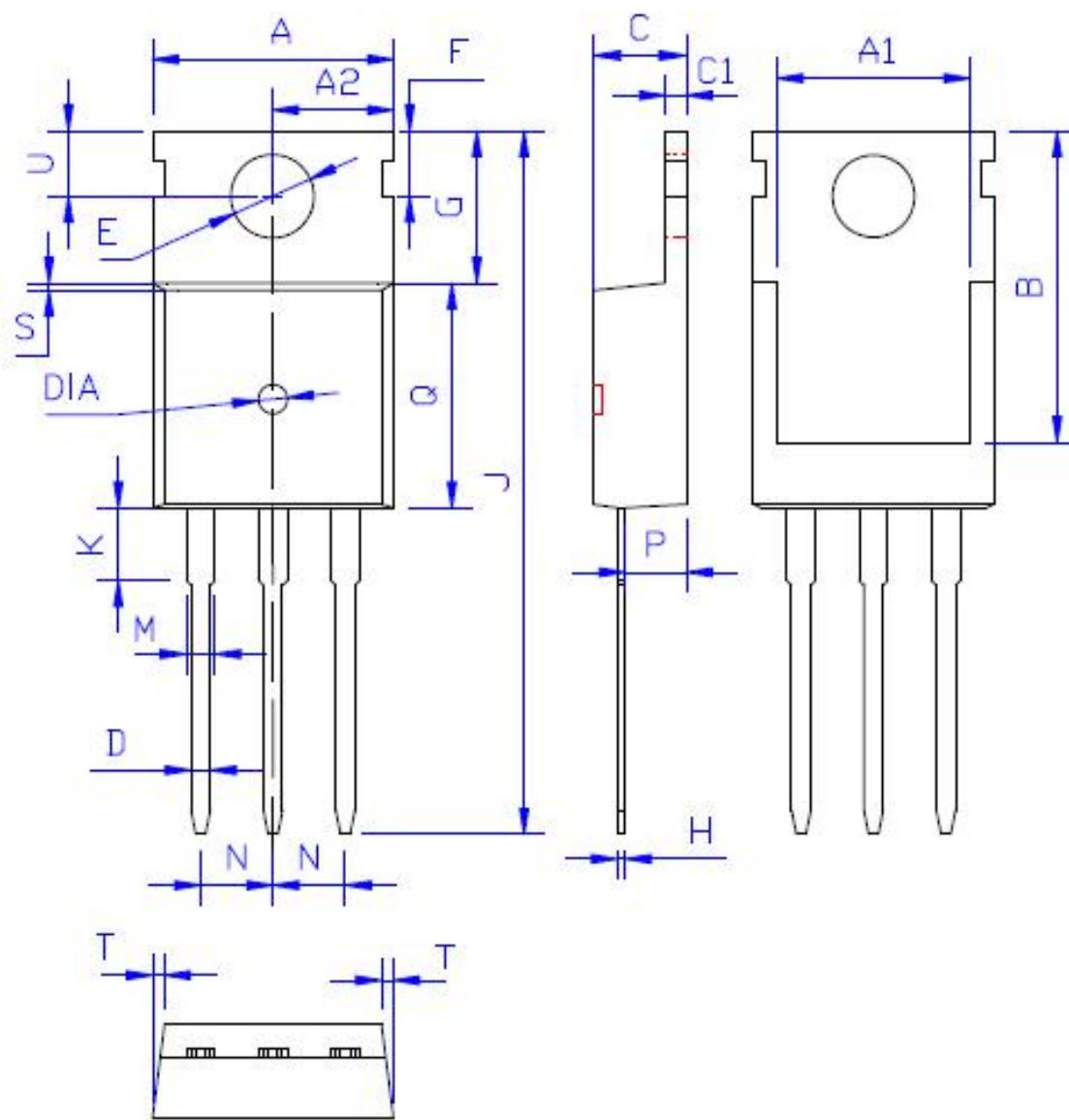
**印记 Marking:**



外形尺寸:

Package Dimension:

TO-220



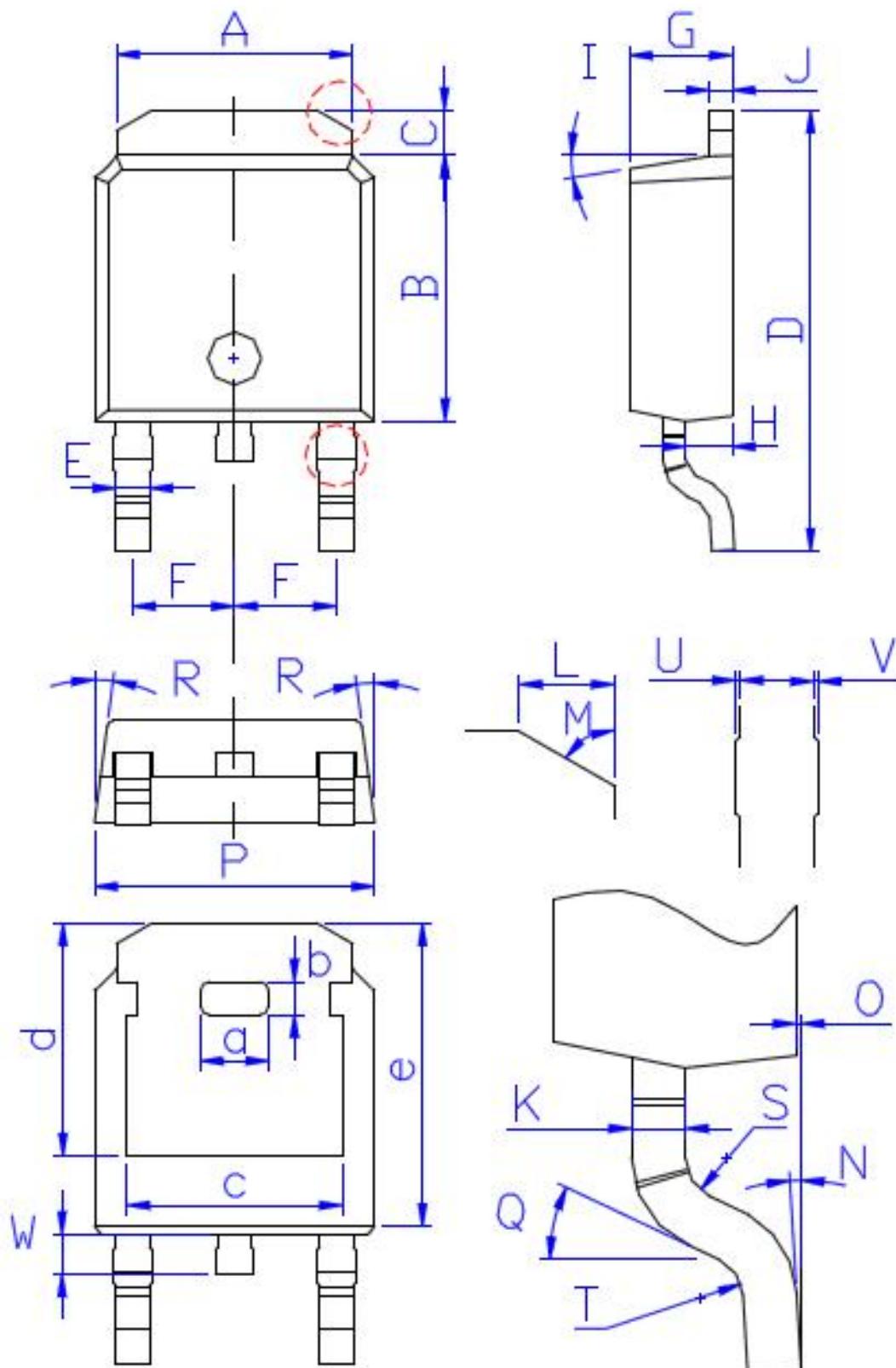
DIM	MILLIMETERS
A	10.00±0.30
A1	8.00±0.30
A2	5.00±0.30
B	13.20±0.40
C	4.50±0.20
C1	1.30±0.20
D	0.80±0.20
E	3.60±0.20
F	3.00±0.30
G	6.60±0.40
H	0.50±0.20
J	28.88±0.50
K	3.00±0.30
M	1.30±0.30
N	Typical 2.54
P	2.40±0.40
Q	9.20±0.40
S	0.25±0.15
T	0.25±0.15
U	2.80±0.30
DIA	宽 1.50±0.10 深 0.50 MAX

(Unit: mm)

外形尺寸:

Package Dimension:

TO-252



DIM	MILLIMETERS
A	5.34±0.30
B	6.00±0.30
C	1.05±0.30
D	9.95±0.30
E	0.76±0.15
F	2.28±0.15
G	2.30±0.30
H	1.06±0.30
I	(4-10)°
J	0.51±0.15
K	0.52±0.15
L	0.80±0.30
M	60°
N	(0-10)°
O	0.05±0.05
P	6.60±0.30
Q	25°
R	(4-8.5)°
S	R0.40
T	R0.40
U	0.05±0.05
V	0.05±0.05
W	0.90±0.30
a	1.80±0.30
b	0.75±0.30
c	4.85±0.30
d	5.30±0.30
e	6.90±0.30

(Units: mm)